

NCE P-Channel Enhancement Mode Power MOSFET

Description

The NCE3401 uses advanced trench technology to provide excellent $R_{DS(ON)}$, low gate charge and operation with gate voltages as low as 2.5V. This device is suitable for use as a load switch or in PWM applications.

General Features

• $V_{DS} = -30V, I_{D} = -4.2A$

 $R_{DS(ON)}$ < 90m Ω @ V_{GS} =-2.5V

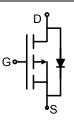
 $R_{DS(ON)}$ < 75m Ω @ V_{GS} =-4.5V

 $R_{DS(ON)} < 55 m\Omega$ @ V_{GS} =-10V

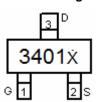
- High power and current handing capability
- Lead free product is acquired
- Surface mount package

Application

- PWM applications
- Load switch
- Power management



Schematic diagram



Marking and Pin Assignment



SOT-23 top view

Package Marking And Ordering Information

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
3401 X	NCE3401	SOT-23	Ø180mm	8 mm	3000 units

Absolute Maximum Ratings (TA=25℃unless otherwise noted)

Parameter	Symbol	Limit	Unit	
Drain-Source Voltage	V _{DS}	-30	V	
Gate-Source Voltage	V _{GS}	±12	V	
Drain Current-Continuous	I _D	-4.2	Α	
Drain Current-Pulsed (Note 1)	I _{DM}	-30	Α	
Maximum Power Dissipation	P _D	1.2	W	
Operating Junction and Storage Temperature Range	T_{J}, T_{STG}	-55 To 150	$^{\circ}$ C	

Thermal Characteristic

Thermal Resistance, Junction-to-Ambient (Note 2)	$R_{ hetaJA}$	104	°C/W
	1 100/1		1

Electrical Characteristics (TA=25°C unless otherwise noted)

Parameter	Symbol	Condition	Min	Тур	Max	Unit
Off Characteristics						
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V I _D =-250μA	-30		-	V
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =-24V,V _{GS} =0V	-	-	-1	μΑ



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NCE3401

Gate-Body Leakage Current	I _{GSS}	V _{GS} =±10V,V _{DS} =0V	-	-	±100	nA
On Characteristics (Note 3)	<u>.</u>					
Gate Threshold Voltage	V _{GS(th)}	V _{DS} =V _{GS} ,I _D =-250μA	-0.7	-1	-1.3	V
		V _{GS} =-10V, I _D =-4.2A	-	48	55	mΩ
Drain-Source On-State Resistance	R _{DS(ON)}	V _{GS} =-4.5V, I _D =-4A	-	56	75	mΩ
		V _{GS} =-2.5V, I _D =-1A		72	90	mΩ
Forward Transconductance	g Fs	V _{DS} =-5V,I _D =-4.2A	-	10	-	S
Dynamic Characteristics (Note4)	<u>.</u>					
Input Capacitance	C _{lss}	\/ - 45\/\/ -0\/	-	880	-	PF
Output Capacitance	C _{oss}	- V _{DS} =-15V,V _{GS} =0V, - F=1.0MHz	-	105	-	PF
Reverse Transfer Capacitance	C _{rss}	F=1.UIVID2	-	65	-	PF
Switching Characteristics (Note 4)	<u>.</u>					
Turn-on Delay Time	t _{d(on)}		-	7	-	nS
Turn-on Rise Time	t _r	V_{DD} =-15V, I_{D} =-4.2A V_{GS} =-10V, R_{GEN} =6 Ω	-	3	-	nS
Turn-Off Delay Time	t _{d(off)}		-	30	-	nS
Turn-Off Fall Time	t _f		-	12	-	nS
Total Gate Charge	Qg		-	8.5	-	nC
Gate-Source Charge	Q _{gs}	V _{DS} =-15V,I _D =-4.2A,V _{GS} =-4.5V	-	1.8	-	nC
Gate-Drain Charge	Q_{gd}		1	2.7	-	nC
Drain-Source Diode Characteristics				•		•
Diode Forward Voltage (Note 3)	V _{SD}	V _{GS} =0V,I _S =-4.2A	_	-	-1.2	V

- Repetitive Rating: Pulse width limited by maximum junction temperature.
 Surface Mounted on FR4 Board, t ≤ 10 sec.
- 3. Pulse Test: Pulse Width ≤ 300µs, Duty Cycle ≤ 2%.
- 4. Guaranteed by design, not subject to production



Typical Electrical and Thermal Characteristics

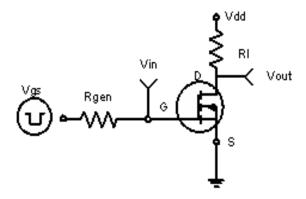
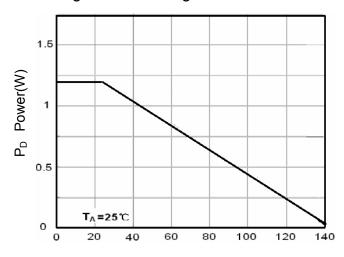
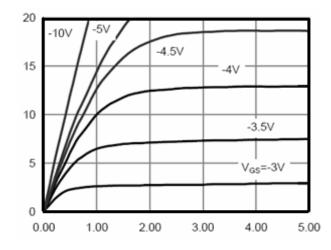


Figure 1:Switching Test Circuit



 T_J -Junction Temperature (${}^{\circ}$ C) Figure 3 Power Dissipation



Ip- Drain Current (A)

Vds Drain-Source Voltage (V) Figure 5 Output Characteristics

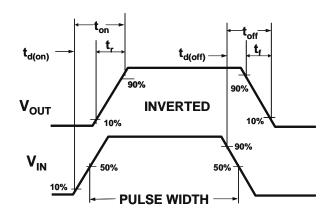


Figure 2:Switching Waveforms

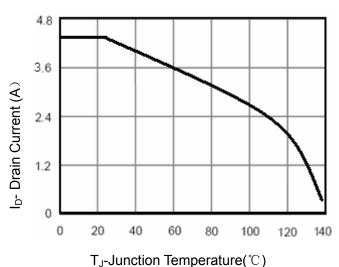


Figure 4 Drain Current

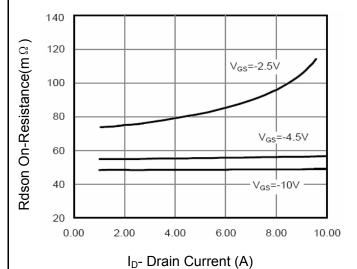
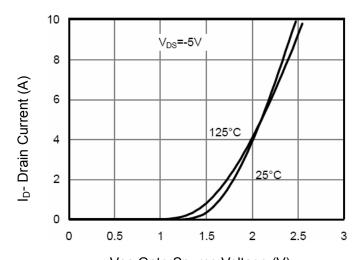
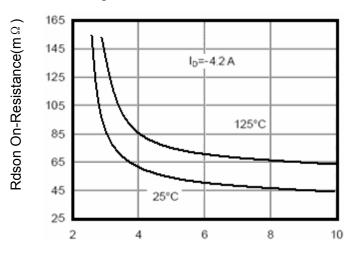


Figure 6 Drain-Source On-Resistance

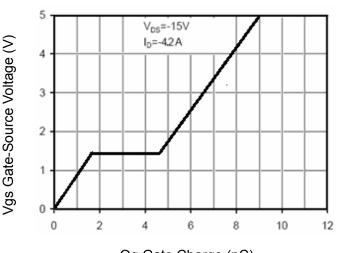




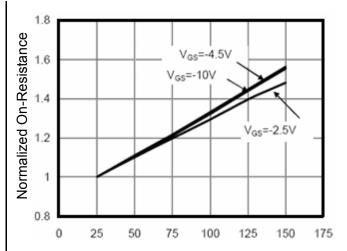
Vgs Gate-Source Voltage (V)
Figure 7 Transfer Characteristics



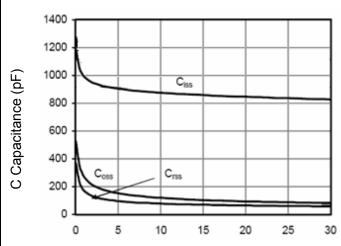
Vgs Gate-Source Voltage (V) Figure 9 Rdson vs Vgs



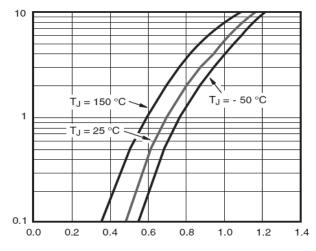
Qg Gate Charge (nC) Figure 11 Gate Charge



$$\label{eq:TJ-Junction} \begin{split} & T_{J}\text{-Junction Temperature}(^{\circ}\!\mathbb{C}\,) \\ & \text{Figure 8 Drain-Source On-Resistance} \end{split}$$



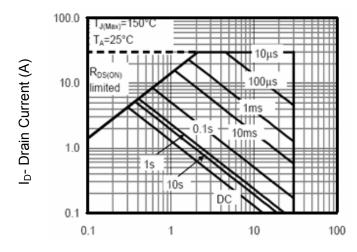
Vds Drain-Source Voltage (V) Figure 10 Capacitance vs Vds



Vsd Source-Drain Voltage (V)
Figure 12 Source- Drain Diode Forward

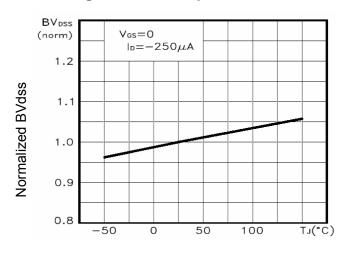
Is- Reverse Drain Current (A)





Vds Drain-Source Voltage (V)

Figure 13 Safe Operation Area



T_J-Junction Temperature(°C)

Figure 14BV_{DSS} vs Junction Temperature

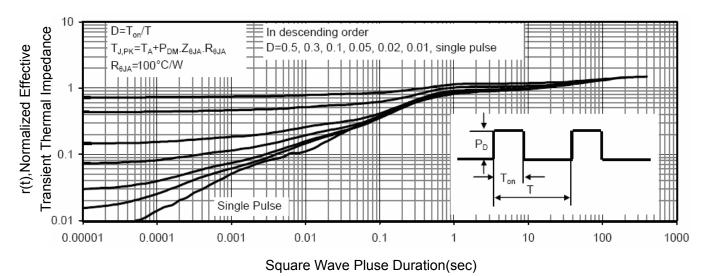
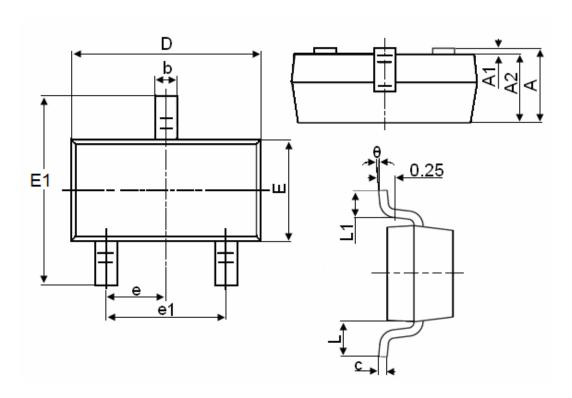


Figure 15Normalized Maximum Transient Thermal Impedance



SOT-23 Package Information



Symbol	Dimensions in Millimeters				
Symbol	MIN.	MAX.			
Α	0.900	1.150			
A1	0.000	0.100			
A2	0.900	1.050			
b	0.300	0.500			
С	0.080	0.150			
D	2.800	3.000			
E	1.200	1.400			
E1	2.250	2.550			
е		0.950TYP			
e1	1.800	2.000			
L		0.550REF			
L1	0.300	0.500			
θ	0°	8°			

Notes

- 1. All dimensions are in millimeters.
- 2. Tolerance ±0.10mm (4 mil) unless otherwise specified
- 3. Package body sizes exclude mold flash and gate burrs. Mold flash at the non-lead sides should be less than 5 mils.
- 4. Dimension L is measured in gauge plane.
- $5. \ Controlling \ dimension \ is \ millimeter, \ converted \ inch \ dimensions \ are \ not \ necessarily \ exact.$



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